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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/612,298	. 07/07/2000	Tatsuya Kunikiyo	193414US2	8554
22850	7590 12/18/2002			
OBLON SPIVAK MCCLELLAND MAIER & NEUSTADT PC			EXAMINER	
	RSON DAVIS HIGHWAY	CAO, PHAT X		
ARLINGTO	N, VA 22202		ART UNIT	PAPER NUMBER
		•	2814	
			DATE MAILED: 12/18/2002	

Please find below and/or attached an Office communication concerning this application or proceeding.

· .		Application No. Applicant(s)			
Office Action Summary		09/612,298	KUNIKIYO, TATSUYA		
		Examiner	Art Unit		
		Phat X. Cao	2814		
Period fo	Th MAILING DATE of this communication app or Reply	ars on the cover sheet with the c	orr spond nc addr ss		
THE - Exte after - If the - If NC - Failu - Any	ORTENED STATUTORY PERIOD FOR REPLY MAILING DATE OF THIS COMMUNICATION. nsions of time may be available under the provisions of 37 CFR 1.13 SIX (6) MONTHS from the mailing date of this communication. period for reply specified above is less than thirty (30) days, a reply period for reply is specified above, the maximum statutory period we are to reply within the set or extended period for reply will, by statute, reply received by the Office later than three months after the mailing and patent term adjustment. See 37 CFR 1.704(b).	16(a). In no event, however, may a reply be tim within the statutory minimum of thirty (30) days ill apply and will expire SIX (6) MONTHS from to cause the application to become ABANDONE	ely filed  will be considered timely. the mailing date of this communication. (35 U.S.C. § 133).		
1)⊠	Responsive to communication(s) filed on 01 N	lovember 2002 .			
2a) <u></u> □	This action is <b>FINAL</b> . 2b)⊠ Thi	s action is non-final.			
3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.  Disposition of Claims					
	Claim(s) <u>1,7-15 and 21-23</u> is/are pending in the	e annlication			
	4a) Of the above claim(s) is/are withdraw	• •			
·	Claim(s) <u>10-12 and 21-23</u> is/are allowed.	The monte of the control of the cont			
	Claim(s) <u>1,7-9 and 13-15</u> is/are rejected.				
·	Claim(s) is/are objected to.				
	Claim(s) are subject to restriction and/or	election requirement			
	on Papers	or out of the out of t			
9) 🗌 .	The specification is objected to by the Examiner.		f		
10)🖾 -	The drawing(s) filed on <u>01 October 2002</u> is/are:	a)⊠ accepted or b)⊡ objected to b	y the Examiner.		
	Applicant may not request that any objection to the	drawing(s) be held in abeyance. Se	e 37 CFR 1.85(a).		
11) 🔲 🗀	The proposed drawing correction filed on	is: a) ☐ approved b) ☐ disapprov	ed by the Examiner.		
	If approved, corrected drawings are required in repl	y to this Office action.			
12) 🔲 ¯	The oath or declaration is objected to by the Exa	miner.			
Priority u	nder 35 U.S.C. §§ 119 and 120				
13)⊠	Acknowledgment is made of a claim for foreign	priority under 35 U.S.C. § 119(a)	-(d) or (f).		
a)[	☑ All b) ☐ Some * c) ☐ None of:				
	1. $\square$ Certified copies of the priority documents	have been received.			
	2. Certified copies of the priority documents have been received in Application No				
	<ol> <li>Copies of the certified copies of the priorit application from the International Bure ee the attached detailed Office action for a list o</li> </ol>	eau (PCT Rule 17.2(a)).	-		
14) 🗌 A	cknowledgment is made of a claim for domestic	priority under 35 U.S.C. § 119(e)	(to a provisional application).		
	☐ The translation of the foreign language prov				
Attachment		-			
2) Notice	e of References Cited (PTO-892) e of Draftsperson's Patent Drawing Review (PTO-948) nation Disclosure Statement(s) (PTO-1449) Paper No(s)	5) Notice of Informal Pa	PTO-413) Paper No(s) atent Application (PTO-152)		

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### **DETAILED ACTION**

## Claim Rejections - 35 USC § 103

- 1. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 2. Claims 1, 7-9, and 13-15 are rejected under 35 U.S.C. 103(a) as being unpatentable over JP. 10-199882 in view of Lee (US. 5,441,915).

With respect to claims 1 and 7-9, JP ('882), in Fig. 2 and abstract, discloses a semiconductor device comprising: a semiconductor substrate 1 having a main surface along which a semiconductor element is formed; interlayer insulating films formed on the main surface; conductive interconnections 3, 5, 7, and 9 provided in a plurality of layers separated by the interlayer insulating films; conductive dummy interconnections 3A, 5A, 7A, 9A, and 12 provided in the plurality of layers so that each conductive dummy interconnection is formed in a layer of the plurality of layers with at least one conductive interconnection, wherein the dummy interconnections are provided to sandwich an interconnection part included in the interconnections in at least one of the two or more layers and wherein the dummy interconnections also comprise a dummy interconnection 12 which is provided in a layer located over the at least one layer to cover the interconnection part; and a conductive dummy plug 4b, 6b,

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8b, and 10b selectively buried in the interlayer insulating films to connect the dummy interconnections all together.

JP ('882) does not disclose the dummy interconnections connected to a potential power supply line.

However, Lee, in column 5, lines 57-65, teaches the obviousness of having the dummy lines left floating or grounded depending on their locations. Accordingly, it would have been obvious to connect the dummy lines of JP ('882) to the ground line because according to Lee, the dummy lines would be grounded when the dummy lines are adjacent to signal lines (see column 5, lines 62-65) for the known purpose of preventing cross-talk.

With respect to claims 13-14, JP ('882) also discloses in Fig. 3 the forming of a passivation film 11 covering the uppermost layer and having a higher thermal conductivity than the interlayer insulating films, and the forming of a heat sink 12 which is in contact with the passivation film 11.

With respect to claim 15, in view of teachings of Fig. 2 of JP ('882), it would have been obvious to modify Fig. 3 of JP ('882) by forming another conductive dummy plug (see dummy plugs 10b in Fig. 2) buried in the passivation film to connect the heat sink 12 and part of the dummy interconnection for the purpose of performing heat dissipation more efficiently (see abstract).

3. Claims 1, 7-9, and 13-15 are rejected under 35 U.S.C. 103(a) as being unpatentable over JP. 10-199882 in view of Ma (US. 5,729,047).

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As discussed in details above, JP ('882) substantially reads on the invention as claimed, except it does not disclose the dummy interconnections connected to a potential power supply line.

However, Ma, in Fig. 3, teaches the obviousness of forming the dummy interconnections surrounding the signal interconnection line 90 and connecting to the potential power supply line Vss. Accordingly, it would have been obvious to connect the dummy interconnections of JP ('882) to the power supply line Vss because according to Ma, such modification would provide a signal isolation and decoupling in an integrated circuit device (column 1, lines 55-60).

## Allowable Subject Matter

4. Claims 10-12 and 21-23 are allowed.

### Response to Arguments

5. With respect to JP('882), Applicant argues that JP('882) does not disclose "each conductive dummy interconnection is formed in a layer of said plurality of layers with at least one conductive interconnection" as amended.

The Examiner disagrees because Fig. 2 of JP('882) clearly discloses the above feature.

With respect to the combination of JP 10-199882 with either Lee or Ma, Applicant argues that it is not obvious to combine them because neither Lee nor Ma teaches the arrangement of a

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Any inquiry of a general nature or relating to the status of this application should be directed to the Group receptionist whose telephone number is (703) 308-0956. Group 2800 fax number is (703) 308-7722 or (703) 308-7724.

PC

November 29, 2002

PHAT X. CAO



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